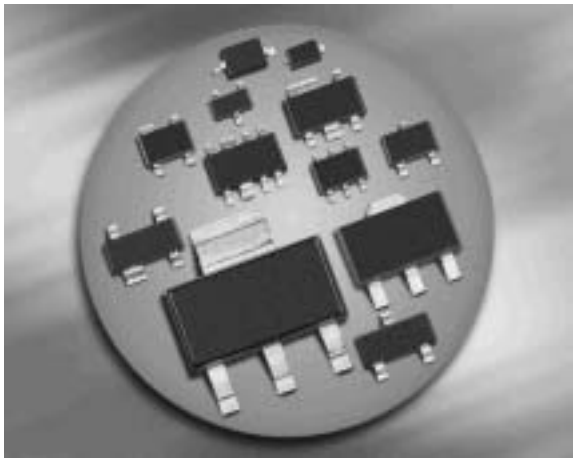
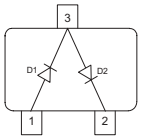
Silicon PIN Diode Array

- Surge protection device
- Designed for surge overvoltage clamping in antiparallel connection
- Pb-free (RoHS compliant) package[1)]
- Qualified according AEC Q101



BAR66



Type	Package	Configuration	L_S(nH)	Marking
BAR66	SOT23	series	1.8	PMs

Maximum Ratings at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	150	V
Forward current	I_F	200	mA
Total power dissipation $T_S \leq 25$ °C	P_{tot}	250	mW
ESD contact discharge[2)]	V_{ESD}	25	kV
Peak pulse current (t_p = 8 / 20 µs)[3)]	I_{pp}	12	A
Junction temperature	T_j	150	°C
Operating temperature range	T_{op}	-55 ... 125	
Storage temperature	T_{stg}	-55 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point[4)], BAR 66	R_{thJS}	≤ 290	K/W

[1]Pb-containing package may be available upon special request
[2]V_{ESD} according to IEC61000-4-2, only valid if pin 1 and pin 2 are connected
[3]I_{pp} according to IEC61000-4-5, only valid if pin 1 and pin 2 are connected
[4]For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at T_A = 25°C, unless otherwise specified

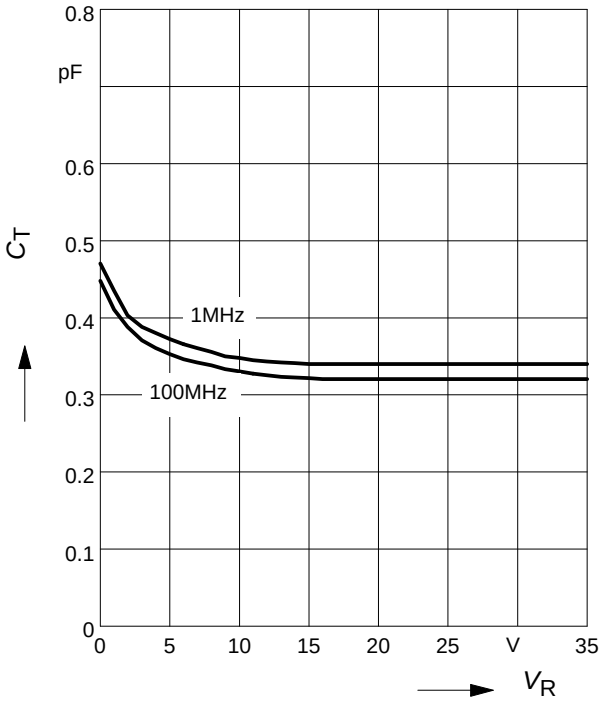
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Breakdown voltage $I_{(BR)}$ = 5 µA	$V_{(BR)}$	150	-	-	V
Reverse current V_R = 100 V	I_R	-	-	20	nA
Forward voltage I_F = 50 mA	V_F	-	0.95	1.2	V
Clamping voltage V_{ESD} = ± 15 kV (contact)[1)] I_{PP} = 12 A, t_p = 8/20 µs[2)]	V_{CL}	 - -	 tbd 7	 - -	
AC Characteristics					
Diode capacitance V_R = 35 V, f = 1 MHz V_R = 0 V, f = 100 MHz	C_T	 - -	 0.4 0.35	 0.6 0.9	pF
Zero bias conductance V_R = 0 V, f = 1 GHz	g_P	-	220	-	µS
Forward resistance I_F = 5 mA, f = 100 MHz	r_f	-	1.5	1.8	Ω
Charge carrier life time I_F = 10 mA, I_R = 6 mA, measured at I_R = 3 mA, R_L = 100 Ω	τ_{rr}	-	0.7	-	µs

[1] V_{ESD} according to IEC61000-4-2, only valid if pin 1 and pin 2 are connected

[2] I_{pp} according to IEC61000-4-5, only valid if pin 1 and pin 2 are connected

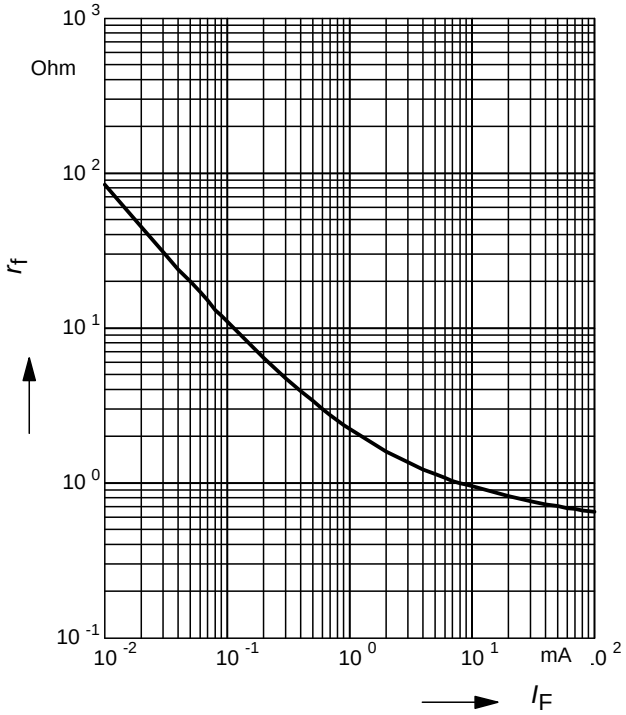
Diode capacitance $C_T = f(V_R)$

f = Parameter



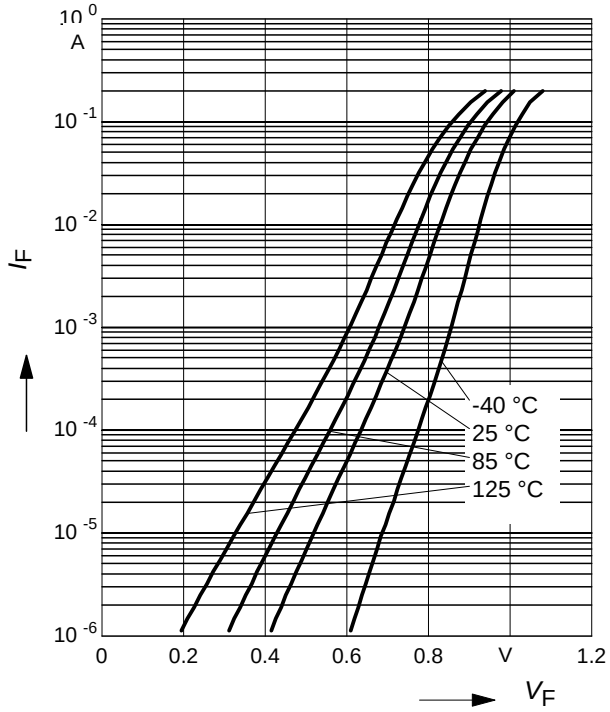
Forward resistance $r_f = f(I_F)$

f = 100MHz



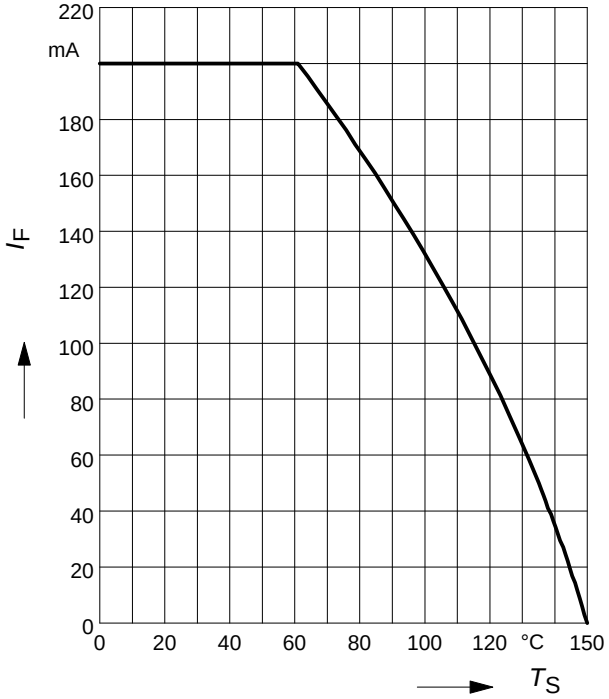
Forward current $I_F = f(V_F)$

T_A = Parameter



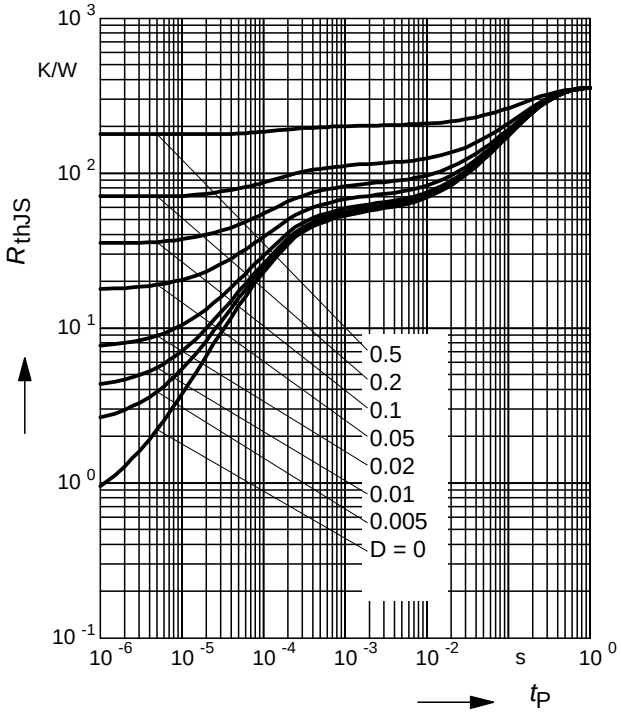
Forward current $I_F = f(T_S)$

BAR66



Permissible Puls Load $R_{thJS} = f(t_p)$

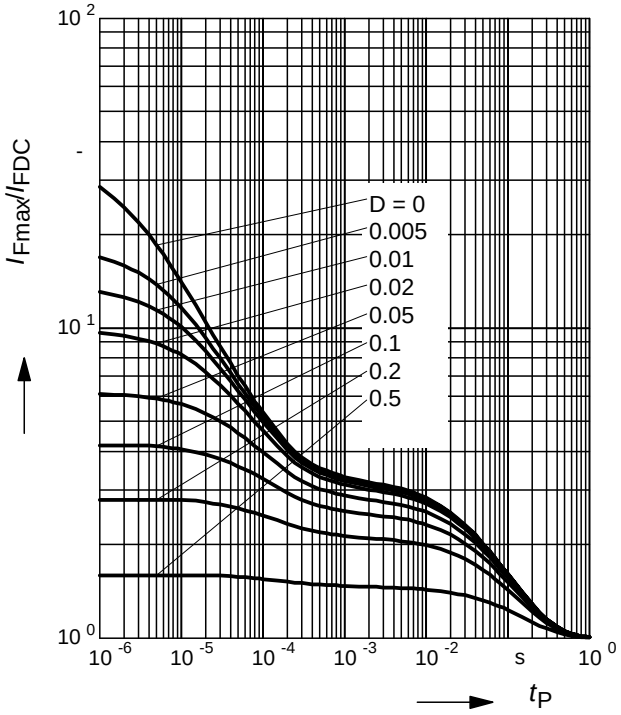
BAR66



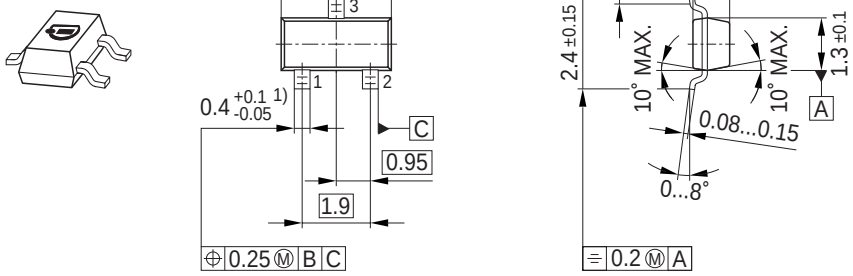
Permissible Pulse Load

$I_{Fmax}/ I_{FDC} = f(t_p)$

BAR66

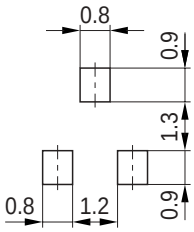


Package Outline

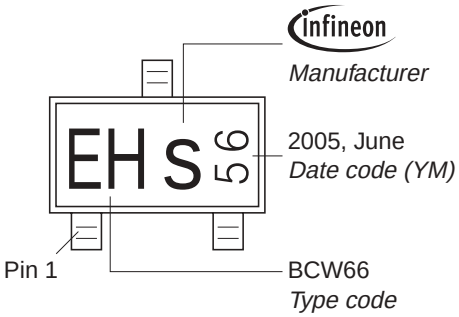


1) Lead width can be 0.6 max. in dambar area

Foot Print

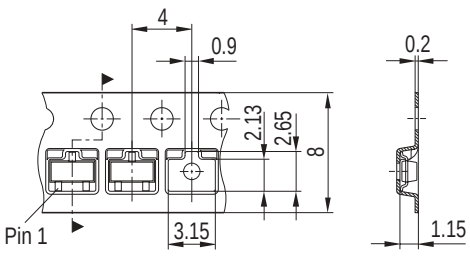


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



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